QPL9097

Ultra-Low Noise, Bypass LNA

General Description

The QPL9097 is a high-linearity, ultra-low noise gain block amplifier with a bypass mode functionality integrated in the product. At 3.8 GHz, the amplifier typically provides 22 dB gain, +34 dBm OIP3, and 1.1 dB noise figure while drawing 50 mA current from a +4.2 V supply.

The QPL9097 is internally matched using a high-performance E-pHEMT process and only requires four external components for operation from a single positive supply: an external RF choke and blocking/bypass capacitors. This low noise amplifier contains an internal active bias to maintain high performance over temperature.

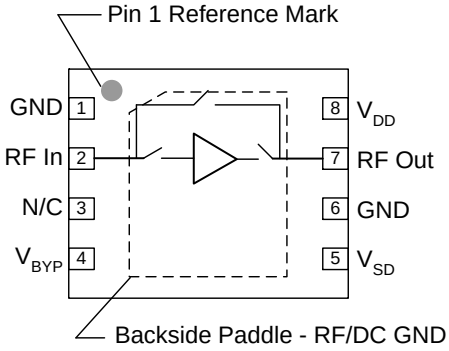
The QPL9097 is optimized for the 3.3 – 4.2 GHz frequency band and is targeted for wireless infrastructure. The QPL9097 is packaged in a 2 x 2 mm DFN.

8 Pin 2X2 mm DFN Package

Product Features

- 3.3 – 4.2 GHz Operational bandwidth
- LNA with integrated bypass mode
- Ability to turn LNA and bypass mode OFF
- Ultra-low noise, 1.1 dB at 3.8 GHz
- 22 dB Gain at 3.8 GHz
- +34 dBm Output IP3 in LNA Mode
- +37 dBm Input IP3 in Bypass Mode
- Internally matched
- Positive supply only, +3.3 to +5 V
- 2x2 mm 8-pin DFN plastic package

Functional Block Diagram



Top View

Applications

- Base-station Receivers
- Repeaters / DAS
- Tower Mounted Amplifiers
- Mobile Infrastructure
- General Purpose Wireless
- TDD or FDD systems

Ordering Information

Part No.	Description
QPL9097TR7	2500 pcs on 7” reel
QPL9097EVBP01	Evaluation Board

Absolute Maximum Ratings

Parameter	Rating
Storage Temperature	−65 to 150°C
Supply Voltage (V_{DD})	+7 V
RF Input Power, CW, 50Ω, T=25°C	+30 dBm

Operation of this device outside the parameter ranges given above may cause permanent damage.

Recommended Operating Conditions

Parameter	Min	Typ	Max	Units
Supply Voltage (V_{DD})	3.0	4.2	5.25	V
T_{CASE}	−40		+105	°C
T_j at T_{CASE} = 125°C			+142	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: V_{DD} = +4.2 V, Temp.=+25°C.

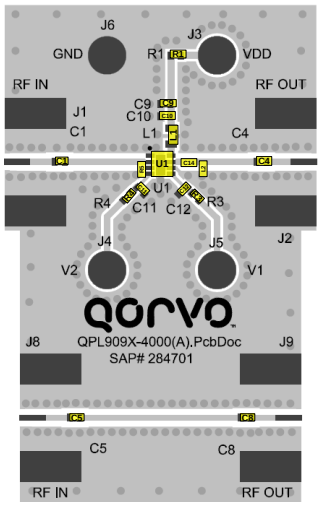
Parameter	Conditions	Min	Typ	Max	Units
Operational Frequency Range		3300		4200	MHz
Test Frequency			3800		MHz
Gain	LNA ON, Bypass OFF	19.5	22	23.5	dB
Input Return Loss	LNA ON, Bypass OFF		12		dB
Output Return Loss	LNA ON, Bypass OFF		11.5		dB
Noise Figure (2)	LNA ON, Bypass OFF		1.1	1.6	dB
Output P1dB (1)	LNA ON, Bypass OFF	+14	+15.5		dBm
Output IP3	LNA ON, Bypass OFF, Pout=+0 dBm/tone, Δf=5 MHz	+30	+34		dBm
Insertion Loss	LNA OFF, Bypass ON		2	3	dB
Return Loss	LNA OFF, Bypass ON		13		dB
Isolation (1)	LNA OFF, Bypass OFF	17	20		dB
Output IP3	LNA OFF, Bypass ON Pin=+3 dBm/tone, Δf=5 MHz	+28	+35		dBm
Control Voltage, V_1, V_2	V_{IH}	1.17		V_{DD}	V
	V_{IL}	0		0.63	V
Current, I_D	LNA ON		50	75	mA
	Bypass ON		5		mA
Switching Time	LNA-Bypass (50% Vctrl to 10% RF)		137	1000	ns
	Bypass-LNA (50% Vctrl to 90% RF)		354	1000	ns
	LNA-OFF (50% Vctrl to 10% RF)		26	1000	ns
	OFF-LNA (50% Vctrl to 90% RF)		55	1000	ns
Thermal Resistance, θ_{jc}	Channel to case		44		°C/W

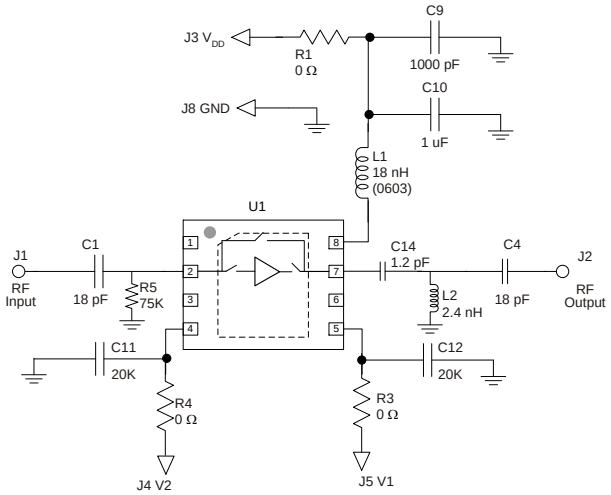
1. Minimum specification listed is guaranteed by design. Not tested in production.
2. Input trace loss de-embedded from noise figure data.

Control Truth Table

V_{BYP}	V_{SD}	State
0	0	LNA ON, Bypass OFF
0	1	LNA OFF, Bypass OFF
1	x	LNA OFF, Bypass ON

QPL9097 Evaluation Board





Notes:

1. A through line is included on the evaluation board to de-embed the board losses.
2. C14 and L2 are placed as close to device as possible. Any trace length between the device and components will add parasitics that will affect the tune.

Bill of Material – QPL9097 Evaluation Board

Reference Des.	Value	Description	Manuf.	Part Number
PCB	--	Printed Circuit Board	Qorvo	
U1	--	Ultra-Low Noise, Bypass LNA	Qorvo	QPL9097
C11, C12	20 KΩ	RES, 0402, 1%, 1/10W	Various	
R1, R3, R4, C4	0 Ω	RES, 0402, +/-5%, 1/16W	Murata	
C1,5,8	18 pF	CAP, 0402, +/-5%, 50V	Murata	
C10	1000 pF	CAP, 0402, 10%, 50V, X7R	Various	
C9	1.0 µF	CAP, 0402, 10%, 10V, X5R	various	
C14	1.2 pF	CAP, 0402, 0.1pF, 50V, C0G	Murata	GJM1555C1H1R2BB01D
L2	2.4 nH	IND, 0402, 5%, WW	Coilcraft	0402CS-2N4XJLW
R5	75 KΩ	RES, 0402, 5%		

Typical Performance (LNA Mode)

Test conditions unless otherwise noted: V_{DD} = +4.2 V, V_1 = 0.63V, V_2 = 0.63V, I_D = 50 mA, Temp.=+25 °C.

Parameter	Typical Value				Units
Frequency	3.4	3.6	3.8	4.0	MHz
Gain	24	23	22	20	dB
Noise Figure	0.9	1.0	1.1	1.2	dB
Input Return Loss	14	12.5	12	11	dB
Output Return Loss	11	11	11.5	12	dB
OIP3 (Pout/tone=+0 dBm, Δf = 1 MHz)	32.5	32.6	32.5	32.2	dBm
P1dB	15.5	15.6	15.5	15.4	dBm

Typical Performance (Bypass Mode)

Test conditions unless otherwise noted: V_{DD} = +4.2 V, V_1 = 1.17V, V_2 = 1.17V or 0.63V, I_d = 5 mA, Temp.=+25 °C.

Parameter	Typical Value				Units
Frequency	3.4	3.6	3.8	4.0	MHz
Insertion Loss	2.2	2.0	2.0	2.0	dB
Input Return Loss	13.5	13	12.5	12	dB
Output Return Loss	14	16.5	17.5	17	dB
Input IP3 (Pin/tone=+3 dBm, Δf = 1 MHz)	39.2	38.2	38	38	dBm

Typical Performance (LNA OFF, Bypass OFF Mode)

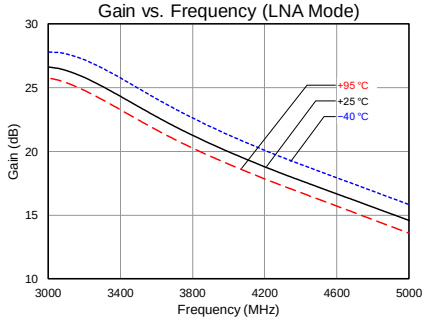
Test conditions unless otherwise noted: V_{DD} = +4.2 V, V_1 = 0.63V, V_2 = 1.17V, Temp. = +25 °C.

Parameter	Typical Value				Units
Frequency	3.4	3.6	3.8	4.0	MHz
Isolation	16.5	18	20	22	dB

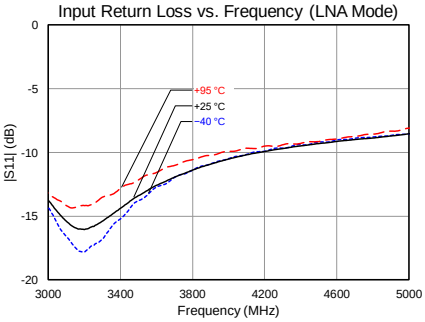
Performance Plots

Test conditions unless otherwise noted: V_{DD} = +4.2 V

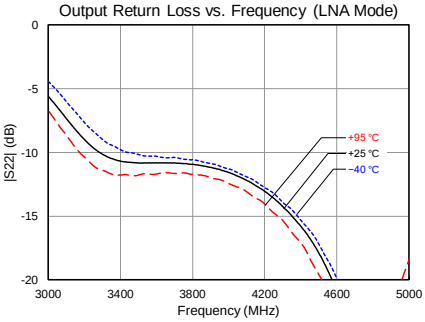
Gain vs. Frequency (LNA Mode)



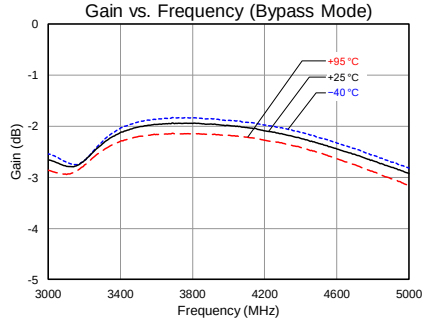
Input Return Loss vs. Frequency (LNA Mode)



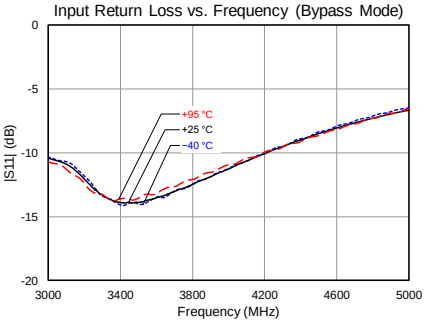
Output Return Loss vs. Frequency (LNA Mode)



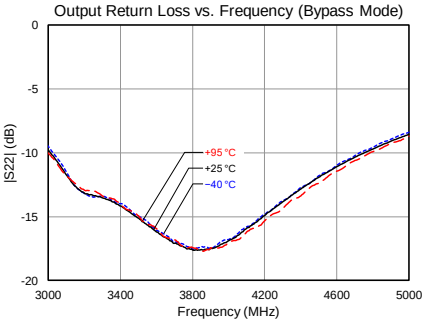
Gain vs. Frequency (Bypass Mode)



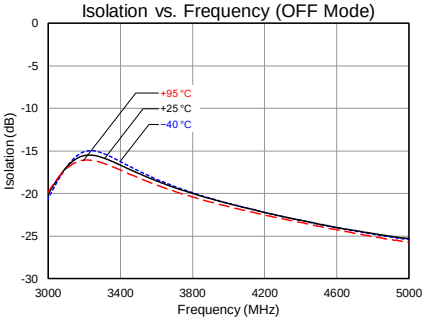
Input Return Loss vs. Frequency (Bypass Mode)



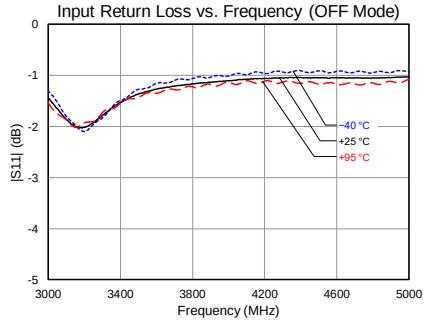
Output Return Loss vs. Frequency (Bypass Mode)



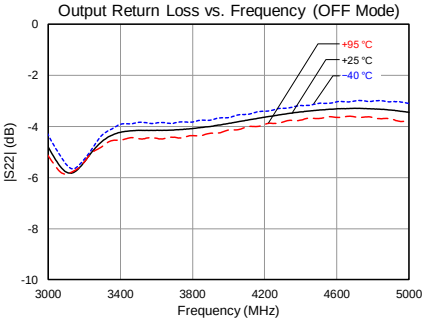
Isolation vs. Frequency (OFF Mode)



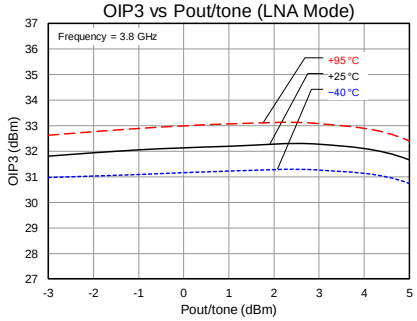
Input Return Loss vs. Frequency (OFF Mode)



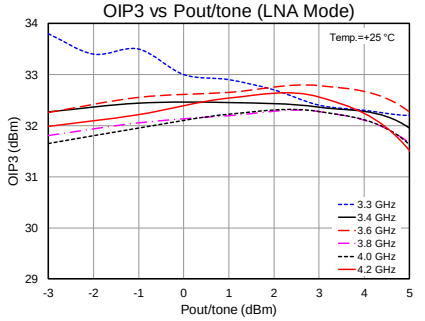
Output Return Loss vs. Frequency (OFF Mode)



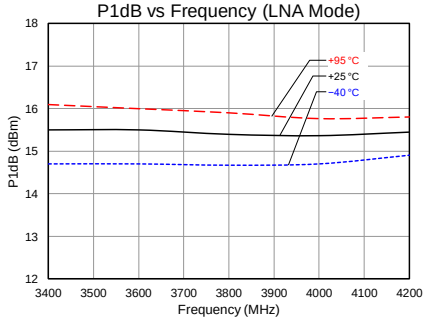
OIP3 vs Pout/tone (LNA Mode)



OIP3 vs Pout/tone (LNA Mode)



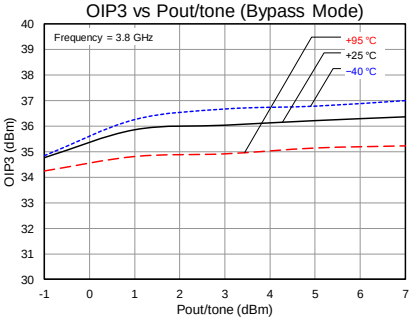
P1dB vs Frequency (LNA Mode)



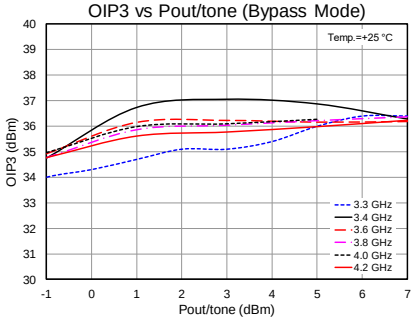
Performance Plots Contd.

Test conditions unless otherwise noted: V_{DD} = +4.2 V

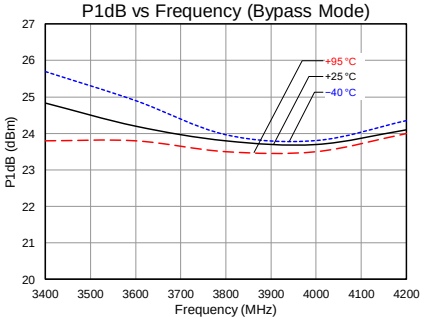
OIP3 vs Pout/tone (Bypass Mode)



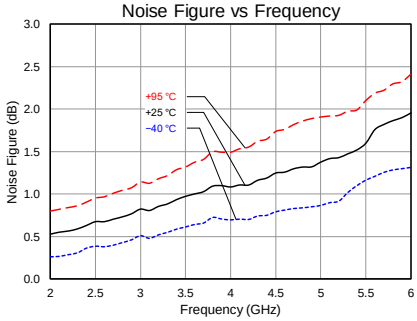
OIP3 vs Pout/tone (Bypass Mode)



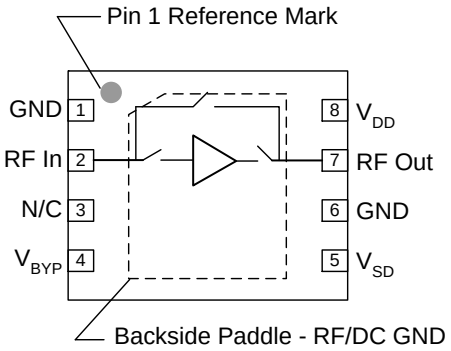
P1dB vs Frequency (Bypass Mode)



Noise Figure vs Frequency



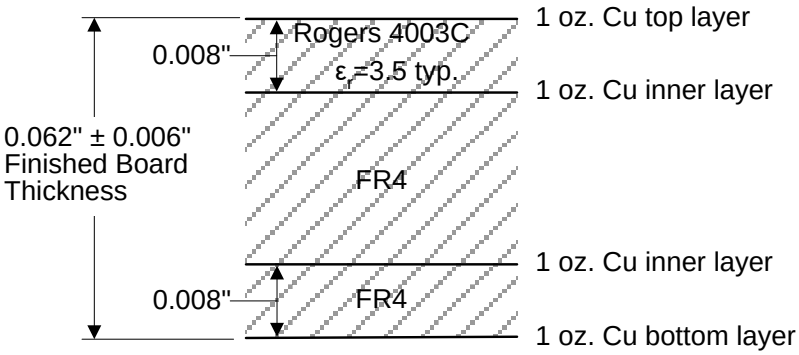
Pin Configuration and Description



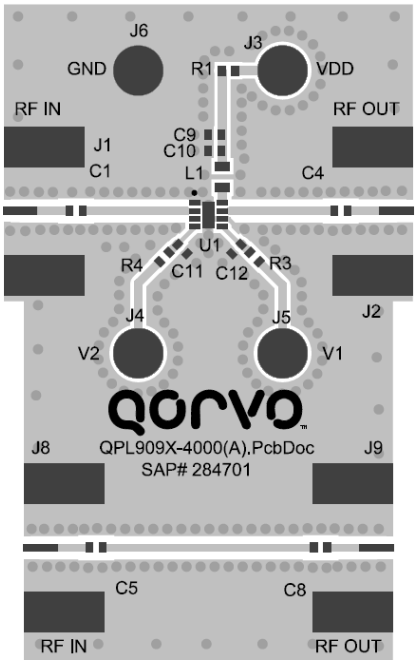
Pin No.	Label	Description
1, 6	GND	RF/DC Ground pin.
2	RF In	RF input pin. DC block required.
3	N/C	No internal connection. Provide grounded PCB land pads for mounting integrity.
4	V_{BYP}	Control pin for bypass mode. The LNA is automatically turned off when the bypass mode is activated. Refer to truth table on page 2.
5	V_{SD}	Control pin to disable the LNA. Refer to truth table on page 2.
7	RF Out	RF output pin. DC block required.
8	V_{DD}	Supply voltage pin. External choke and bypass capacitors needed.
Backside Paddle	RF/DC GND	RF/DC Ground. Follow recommended via hole pattern and ensure good solder attach for best thermal and electrical performance.

Evaluation Board PCB Information

Qorvo PCB 284701 Material and Stack-up

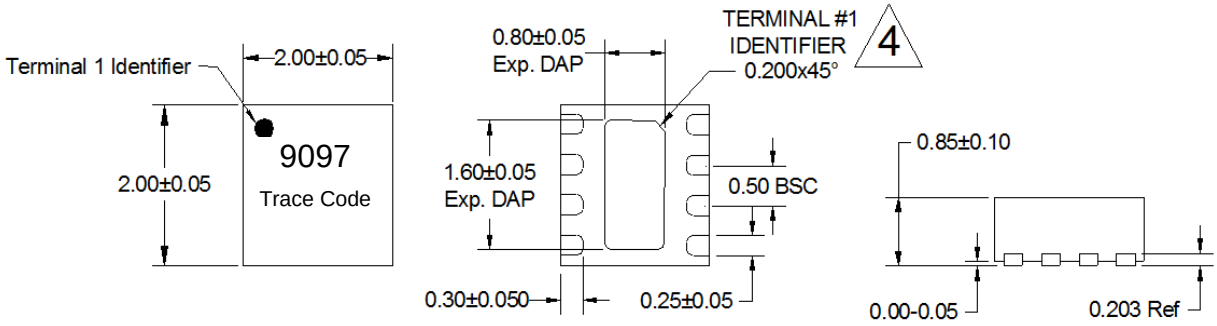


50 ohm line dimensions: width = 0.0182”, spacing = 0.020”



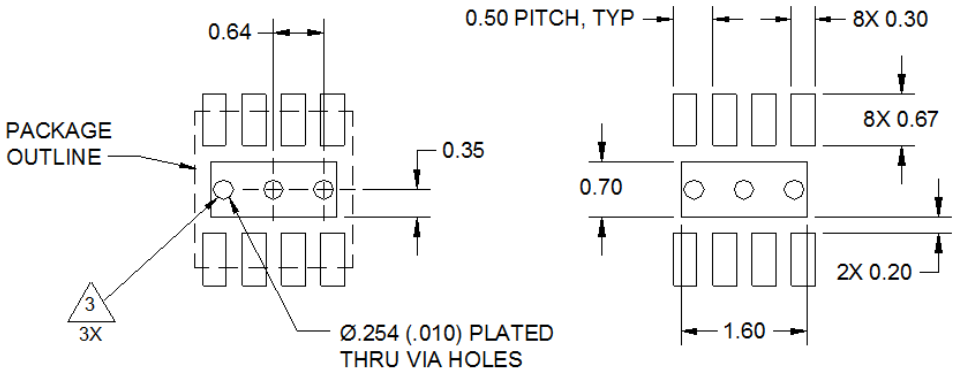
Mechanical Information

Package Marking and Dimensions



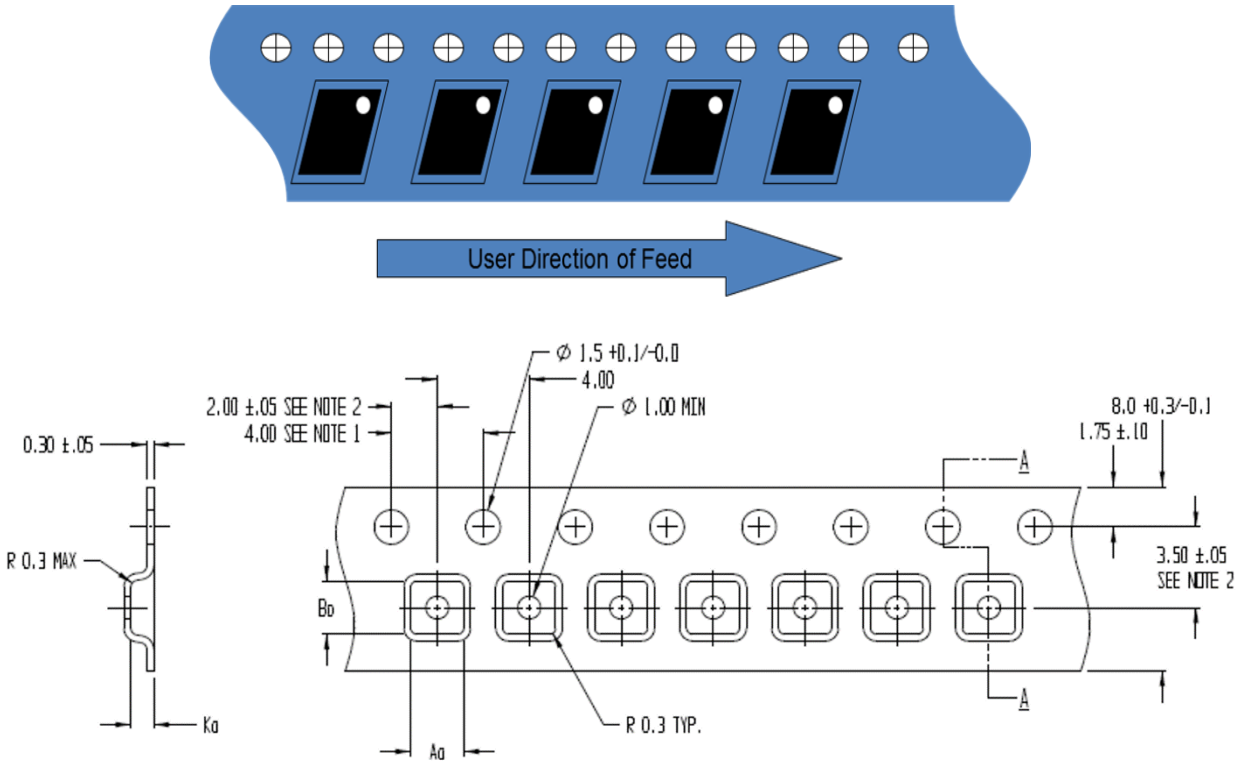
Notes:
1. All dimensions are in millimeters. Angles are in degrees.
2. Except where noted, this part outline conforms to JEDEC standard MO-220, Issue E (Variation VGGC) for thermally enhanced plastic very thin fine pitch quad flat no lead package (QFN).
3. Dimension and tolerance formats conform to ASME Y14.4M-1994.
4. The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.

PCB Mounting Pattern



Notes:
1. All dimensions are in millimeters. Angles are in degrees.
2. Use 1 oz. copper minimum for top and bottom layer metal.
3. Via holes are required under the backside paddle of this device for proper RF/DC grounding and thermal dissipation. We recommend a 0.35mm (#80/.0135") diameter bit for drilling via holes and a final plated thru diameter of 0.25 mm (0.01”).
4. Ensure good package backside paddle solder attach for reliable operation and best electrical performance.

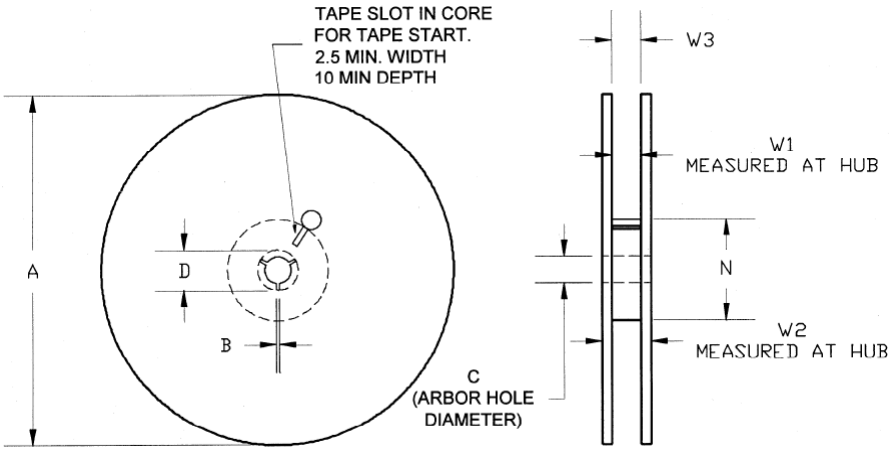
Tape and Reel Information – Carrier and Cover Tape Dimensions



Feature	Measure	Symbol	Size (in)	Size (mm)
Cavity	Length	A0	0.091	2.30
	Width	B0	0.091	2.30
	Depth	K0	0.051	1.30
	Pitch	P1	0.157	4.00
Centerline Distance	Cavity to Perforation - Length Direction	P2	0.079	2.00
	Cavity to Perforation - Width Direction	F	0.138	3.50
Cover Tape	Width	C	0.213	5.40
Carrier Tape	Width	W	0.315	8.00

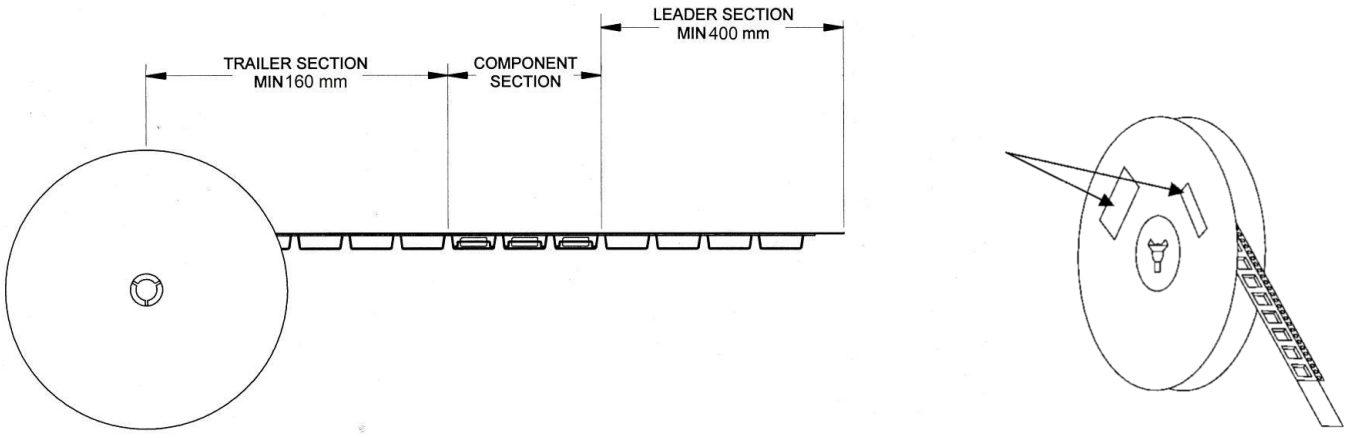
Tape and Reel Information – Reel Dimensions

Standard T/R size = 2,500 pieces on a 7” reel.



Feature	Measure	Symbol	Size (in)	Size (mm)
Flange	Diameter	A	6.969	177.0
	Thickness	W2	0.559	14.2
	Space Between Flange	W1	0.346	8.8
Hub	Outer Diameter	N	2.293	58.0
	Arbor Hole Diameter	C	0.512	13.0
	Key Slit Width	B	0.079	2.0
	Key Slit Diameter	D	0.787	20.0

Tape and Reel Information – Tape Length and Label Placement



Notes:
1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.
2. Labels are placed on the flange opposite the sprockets in the carrier tape.

Handling Precautions

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 1B	ESDA / JEDEC JS-001-2014
ESD – Charged Device Model (CDM)	Class C3	ESDA / JEDEC JS-002-2014
MSL – Moisture Sensitivity Level	Level 1	IPC/JEDEC J-STD-020

Caution!
ESD-Sensitive Device

Solderability

Compatible with lead-free (260°C max. reflow temp.) soldering process.
Solder profiles available upon request.

Contact plating: NiPdAu

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A ($C_{15}H_{12}Br_4O_2$) Free
- PFOS Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: www.qorvo.com **Tel: 1-844-890-8163**

Email: customer.support@qorvo.com

For technical questions and application information:

Email: appsupport@qorvo.com

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